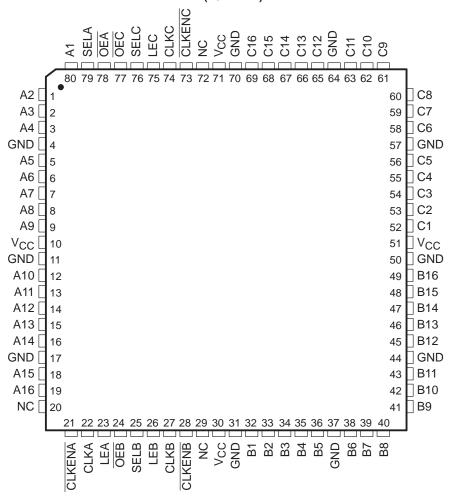
SCBS179E - JUNE 1992 - REVISED MAY 1997

- **Members of the Texas Instruments** Widebus+™ Family
- State-of-the-Art *EPIC-IIB™* BiCMOS Design Significantly Reduces Power Dissipation
- **UBE** ™ (Universal Bus Exchanger) **Combines D-Type Latches and D-Type** Flip-Flops for Operation in Transparent, Latched, Clocked, or Clock-Enabled Mode
- **ESD Protection Exceeds 2000 V Per** MIL-STD-883, Method 3015
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V_{OLP} (Output Ground Bounce) $< 0.8 \text{ V at V}_{CC} = 5 \text{ V}, T_A = 25^{\circ}\text{C}$

- **High-Impedance State During Power Up** and Power Down
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- High-Drive Outputs (-32-mA I_{OH}, 64-mA I_{OL})
- Bus Hold on Data Inputs Eliminates the **Need for External Pullup/Pulldown** Resistors
- Package Options Include 80-Pin Plastic Thin Quad Flat (PN) Package With 12 × 12-mm Body Using 0.5-mm Lead Pitch and 84-Pin Ceramic Quad Flat (HT) Package

'ABTH32316 . . . PN PACKAGE (TOP VIEW)

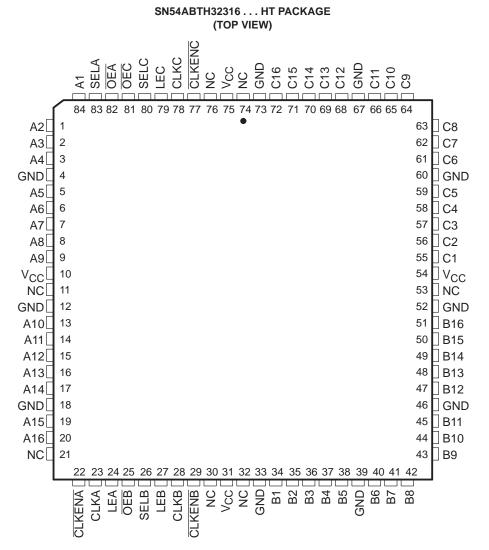




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NC - No internal connection

description

The 'ABTH32316 consist of three 16-bit registered input/output (I/O) ports. These registers combine D-type latches and flip-flops to allow data flow in transparent, latch, and clock modes. Data from one input port can be exchanged to one or more of the other ports. Because of the universal storage element, multiple combinations of real-time and stored data can be exchanged among the three ports.

Data flow in each direction is controlled by the output-enable (\overline{OEA} , \overline{OEB} , and \overline{OEC}), select-control (SELA, SELB, and SELC), latch-enable (LEA, LEB, and LEC), and clock (CLKA, CLKB, and CLKC) inputs. The A data register operates in the transparent mode when LEA is high. When LEA is low, data is latched if CLKA is held at a high or low logic level. If LEA and clock-enable A (\overline{CLKENA}) are low, data is stored on the low-to-high transition of CLKA. Output data selection is accomplished by the select-control pins. All three ports have active-low output enables, so when the output-enable input is low, the outputs are active; when the output-enable input is high, the outputs are in the high-impedance state.

When V_{CC} is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.



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description (continued)

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN54ABTH32316 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ABTH32316 is characterized for operation from –40°C to 85°C.

Function Tables

STORAGE[†]

| | INPUT | ·S | | OUTDUT |
|--------|------------|-------|---|--------------------------------------|
| CLKENA | CLKA | LEA A | | OUTPUT |
| Н | Х | L | Χ | Q ₀ ‡ |
| L | \uparrow | L | L | L |
| L | \uparrow | L | Н | Н |
| Х | Н | L | Χ | Q ₀ ‡ |
| Х | L | L | Χ | Q ₀ ‡ Q ₀ ‡ |
| Х | X | Н | L | L |
| Х | Х | Н | Н | Н |

[†] A-port register shown. B and C ports are similar but use CLKENB, CLKENC, CLKB, CLKC, LEB, and LEC.

A-PORT OUTPUT

| INP | UTS | OUTPUT A | | | | | |
|-----|------|----------------------|--|--|--|--|--|
| OEA | SELA | OUTPUT A | | | | | |
| Н | Х | Z | | | | | |
| L | Н | Output of C register | | | | | |
| L | L | Output of B register | | | | | |

B-PORT OUTPUT

| | INP | UTS | OUTPUT D |
|---|-----|------|----------------------|
| E | OEB | SELB | OUTPUT B |
| Г | Н | Χ | Z |
| | L | Н | Output of A register |
| | L | L | Output of C register |

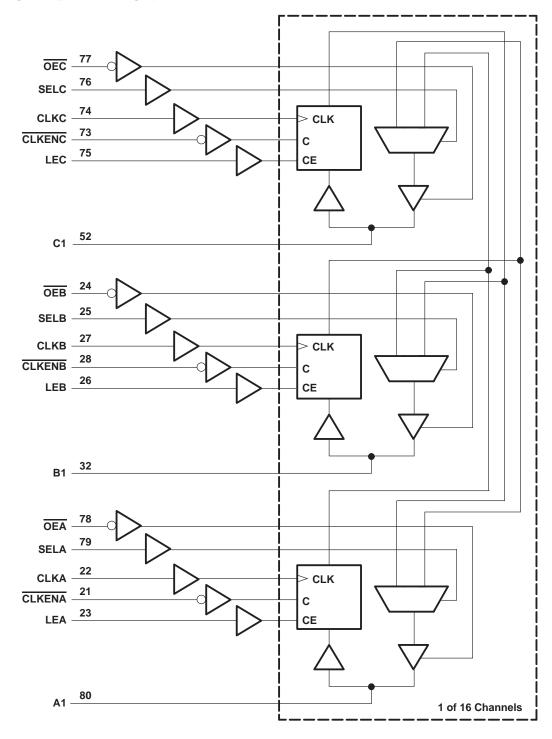
C-PORT OUTPUT

| II | NPUTS | OUTPUT C |
|----|-------|----------------------|
| OE | SELC | OUTPUT C |
| Н | Х | Z |
| L | Н | Output of B register |
| L | L | Output of A register |



[‡]Output level before the indicated steady-state input conditions were established

logic diagram (positive logic)



Pin numbers shown are for the PN package.



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range, V _{CC} | –0.5 V to 7 V |
|--|-----------------|
| Input voltage range, V _I (except I/O ports) (see Note 1) | 0.5 V to 7 V |
| Voltage range applied to any output in the high or power-off state, VO | –0.5 V to 5.5 V |
| Current into any output in the low state, I _O : SN54ABTH32316 | 96 mA |
| SN74ABTH32316 | 128 mA |
| Input clamp current, I _{IK} (V _I < 0) | –18 mA |
| Output clamp current, I _{OK} (V _O < 0) | –50 mA |
| Package thermal impedance, θ _{JA} (see Note 2): PN package | 62°C/W |
| Storage temperature range, T _{stq} | –65°C to 150°C |

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 3)

| | | | SN54ABTI | H32316 | SN74ABTI | UNIT | | |
|---------------------|------------------------------------|-----------------|----------|--------|----------|------|------|--|
| | | | MIN | MAX | MIN | MAX | ONT | |
| Vcc | Supply voltage | | 4.5 | 5.5 | 4.5 | 5.5 | V | |
| VIH | High-level input voltage | | 2 | | 2 | | V | |
| V _{IL} | Low-level input voltage | | 0.8 | | 0.8 | V | | |
| VI | Input voltage | | 0 | Vcc | 0 | Vcc | V | |
| IOH | High-level output current | | | -24 | | -32 | mA | |
| loL | Low-level output current | | | 48 | | 64 | mA | |
| Δt/Δν | Input transition rise or fall rate | Outputs enabled | | 10 | | 10 | ns/V | |
| Δt/ΔV _{CC} | Power-up ramp rate | | 200 | | 200 | | μs/V | |
| TA | Operating free-air temperature | | -55 | 125 | -40 | 85 | °C | |

NOTE 3: Unused control pins must be held high or low to prevent them from floating.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

^{2.} The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.

SN54ABTH32316, SN74ABTH32316 16-BIT TRI-PORT UNIVERSAL BUS EXCHANGERS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| | ADAMETED | TEST COME | NTIONS | SN54 | 4ABTH3 | 2316 | SN74 | ABTH32 | 2316 | LINUT | |
|--------------------|------------------|---|--|------|------------------|------|------|------------------|------|-------|--|
| " | ARAMETER | TEST COND | IIIONS | MIN | TYP [†] | MAX | MIN | TYP [†] | MAX | UNIT | |
| VIK | | V _{CC} = 4.5 V, | $c = 4.5 \text{ V},$ $I_{\parallel} = -18 \text{ mA}$ | | | -1.2 | | | -1.2 | V | |
| | | $V_{CC} = 4.5 \text{ V},$ | $I_{OH} = -3 \text{ mA}$ | 2.5 | | | 2.5 | | | | |
| \/~ | | V _{CC} = 5 V, | $I_{OH} = -3 \text{ mA}$ | 3 | | | 3 | | | V | |
| VOH | | V _{CC} = 4.5 V | I _{OH} = -24 mA | 2 | | | | | | V | |
| | | VCC = 4.5 V | $I_{OH} = -32 \text{ mA}$ | | | | 2 | | | | |
| VOL | | V _{CC} = 4.5 V | I _{OL} = 48 mA | | | 0.55 | | | | V | |
| VOL | | VCC = 4.5 V | $I_{OL} = 64 \text{ mA}$ | | | | | | 0.55 | V | |
| V _{hys} | | | | | 100 | | | 100 | | mV | |
| 1. | Control inputs | $V_{CC} = 0 \text{ to } 5.5 \text{ V},$ | $V_I = V_{CC}$ or GND | | | ±1 | | | ±1 | μА | |
| 1 | A, B, or C ports | $V_{CC} = 2.1 \text{ V to } 5.5 \text{ V},$ | $V_I = V_{CC}$ or GND | | | ±100 | | | ±20 | | |
| len en | A D == 0 ===== | VCC = 4.5 V | V _I = 0.8 V | 100 | | | 100 | | | μА | |
| l(hold) | A, B, or C ports | VCC = 4.5 V | V _I = 2 V | -100 | | | -100 | | | μΑ | |
| lozpu [‡] | ‡ | $V_{CC} = 0 \text{ to } 2.1 \text{ V, } V_{O} = 0.5$ | | | ±50 | | | ±50 | μΑ | | |
| lozpd ² | ‡ | $V_{CC} = 2.1 \text{ V to } 0, V_{O} = 0.5$ | 5 V to 2.7 V, OE = X | | | ±50 | | | ±50 | μΑ | |
| l _{off} | | $V_{CC} = 0$, | V_I or $V_O \le 4.5 \text{ V}$ | | | ±100 | | | ±100 | μΑ | |
| ICEX | | $V_{CC} = 5.5 \text{ V}, V_{O} = 5.5 \text{ V}$ | Outputs high | | | 50 | | | 50 | μΑ | |
| IO§ | | V _{CC} = 5.5 V, | V _O = 2.5 V | -50 | -100 | -180 | -50 | -100 | -180 | mA | |
| | | V _{CC} = 5.5 V, | Outputs high | | | 2 | | | 2 | | |
| ICC | | $I_{O} = 0$, | Outputs low | | | 40 | | | 40 | mA | |
| | | $V_I = V_{CC}$ or GND | Outputs disabled | | 1 | | | 1 | | | |
| Δlcc¶ | | V _{CC} = 5.5 V, One input at Other inputs at V _{CC} or GN | $_{CC}$ = 5.5 V, One input at 3.4 V, ther inputs at V_{CC} or GND | | | 1 | | | 0.5 | mA | |
| Ci | Control inputs | V _I = 2.5 V or 0.5 V | | | 3 | | | 3 | | pF | |
| C _{io} | A, B, or C ports | V _O = 2.5 V or 0.5 V | | | 11.5 | | | 11.5 | | pF | |

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

| | | | SN54ABTI | H32316 | SN74ABTI | UNIT | | |
|-----------------|-----------------|------------------------|----------|--------|----------|------|-----|--|
| | | MIN | MAX | MIN | MAX | UNIT | | |
| fclock | Clock frequency | | 0 | 150 | 0 | 150 | MHz | |
| | Pulse duration | LE high | 3.3 | | 3.3 | | ns | |
| t _W | ruise duration | CLK high or low | 3.3 | | 3.3 | | | |
| | | A, B, or C before CLK↑ | 2.6 | | 2.4 | | | |
| t _{su} | Setup time | A or B before LE↓ | 2.5 | | 2.1 | | ns | |
| | | CLKEN before CLK↑ | 3.5 | | 3.2 | | | |
| | | A, B, or C after CLK↑ | 1.8 | | 1.4 | | | |
| th | Hold time | A or B after LE↓ | 2.4 | | 2.1 | | ns | |
| | | CLKEN after CLK↑ | 1.5 | | 1.1 | | | |



[‡]This parameter is specified by characterization.

[§] Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

 $[\]P$ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

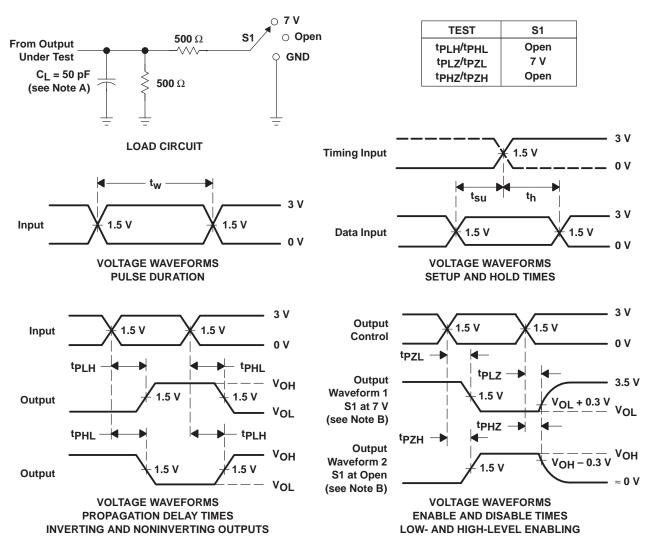
SN54ABTH32316, SN74ABTH32316 16-BIT TRI-PORT UNIVERSAL BUS EXCHANGERS

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switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L = 50 pF (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM | то | SN54ABT | H32316 | SN74ABTI | UNIT | |
|------------------|---------------------------|------------|---------|--------|----------|------|-------|
| FARAMETER | (INPUT) | (OUTPUT) | MIN | MAX | MIN | MAX | CIVIT |
| f _{max} | | | 150 | | 150 | | MHz |
| ^t PLH | A, B, or C | C, B, or A | 0.8 | 6.5 | 1.4 | 6.1 | ns |
| ^t PHL | A, b, or C | C, B, 01 A | 0.5 | 6.8 | 1.1 | 6.6 | 115 |
| ^t PLH | SEL | A, B, or C | 0.8 | 6.7 | 1.4 | 6.5 | ns |
| ^t PHL | JEL | A, B, 01 C | 0.8 | 6.8 | 1.8 | 6.5 | 115 |
| ^t PLH | LE | A, B, or C | 1.5 | 8 | 2.6 | 7.5 | ns |
| ^t PHL | | A, B, OI C | 1.5 | 7.4 | 2.6 | 6.9 | 115 |
| ^t PLH | CLK | A, B, or C | 1.5 | 8 | 2.5 | 7.5 | ns |
| ^t PHL | CLK | A, B, OI C | 1.5 | 7.2 | 2.5 | 6.7 | 115 |
| ^t PZH | OE | A, B, or C | 0.8 | 6.7 | 1.5 | 6.4 | no |
| t _{PZL} | | A, B, 01 C | 1.5 | 7.1 | 2.4 | 6.8 | ns |
| ^t PHZ | OE | A, B, or C | 0.8 | 7.2 | 1.5 | 6 | ns |
| t _{PLZ} | | A, B, 01 C | 0.8 | 6.4 | 1.9 | 6.1 | 115 |

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_{Q} = 50 Ω , t_{f} \leq 2.5 ns, t_{f} \leq 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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PACKAGING INFORMATION

| Orderable part number | Status | Material type | Package Pins | Package qty Carrier | RoHS | Lead finish/ Ball material | MSL rating/ Peak reflow | Op temp (°C) | Part marking (6) |
|-----------------------|--------|---------------|----------------|----------------------------|------|-------------------------------|----------------------------|--------------|---|
| | | | | | | (4) | (5) | | |
| 5962-9680801QXA | Active | Production | CFP (HT) 84 | 250 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | 5962-9680801QX A SNJ54ABTH32316 HT |
| SN74ABTH32316PN | Active | Production | LQFP (PN) 80 | 119 JEDEC TRAY (10+1) | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 85 | ABTH32316 |
| SN74ABTH32316PN.B | Active | Production | LQFP (PN) 80 | 119 JEDEC TRAY (10+1) | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 85 | ABTH32316 |
| SNJ54ABTH32316HT | Active | Production | CFP (HT) 84 | 250 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | 5962-9680801QX A SNJ54ABTH32316 HT |

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

PACKAGE OPTION ADDENDUM

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OTHER QUALIFIED VERSIONS OF SN54ABTH32316, SN74ABTH32316:

Catalog: SN74ABTH32316

Military: SN54ABTH32316

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TUBE



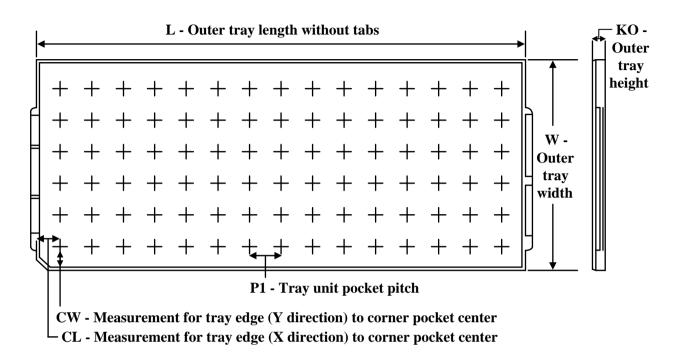
*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| 5962-9680801QXA | HT | CFP | 84 | 250 | 506.98 | 17.91 | 12570 | 5.46 |
| SNJ54ABTH32316HT | HT | CFP | 84 | 250 | 506.98 | 17.91 | 12570 | 5.46 |



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TRAY



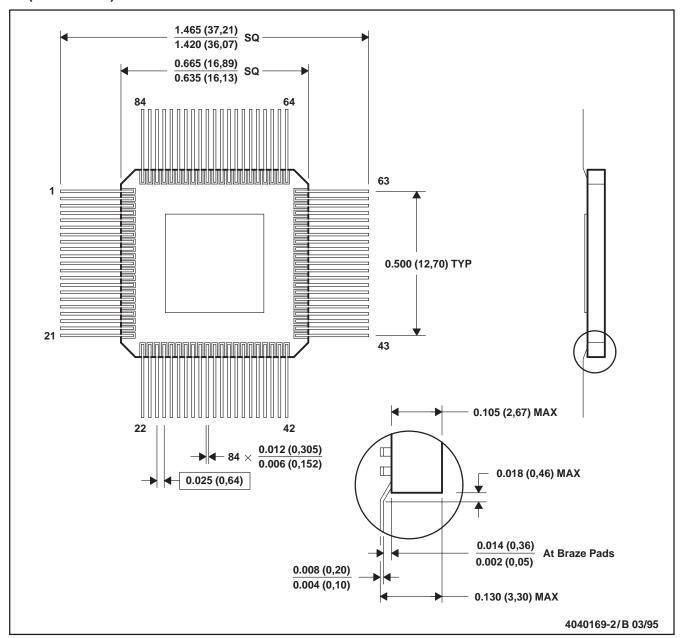
Chamfer on Tray corner indicates Pin 1 orientation of packed units.

*All dimensions are nominal

| | - | | | | | | | | | | | |
|-------------------|-----------------|-----------------|------|-----|----------------------|----------------------------|--------|-----------|------------|------------|------------|------------|
| Device | Package Name | Package Type | Pins | SPQ | Unit array matrix | Max temperature (°C) | L (mm) | W (mm) | Κ0 (μm) | P1 (mm) | CL (mm) | CW (mm) |
| SN74ABTH32316PN | PN | LQFP | 80 | 119 | 7 x 17 | 150 | 315 | 135.9 | 7620 | 17.9 | 14.3 | 13.95 |
| SN74ABTH32316PN.B | PN | LQFP | 80 | 119 | 7 x 17 | 150 | 315 | 135.9 | 7620 | 17.9 | 14.3 | 13.95 |

HT (S-CQFP-F84)

CERAMIC QUAD FLATPACK



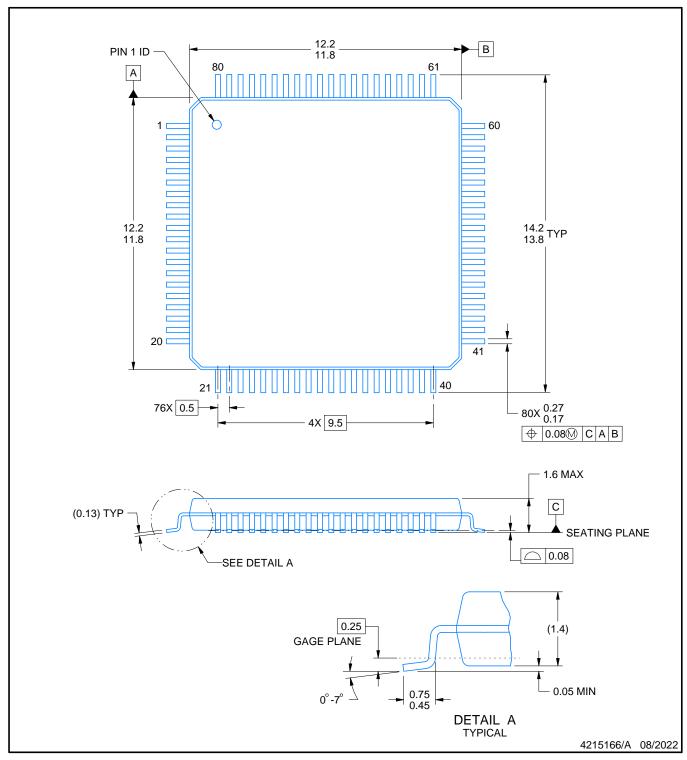
NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MO-090 AA





PLASTIC QUAD FLATPACK



NOTES:

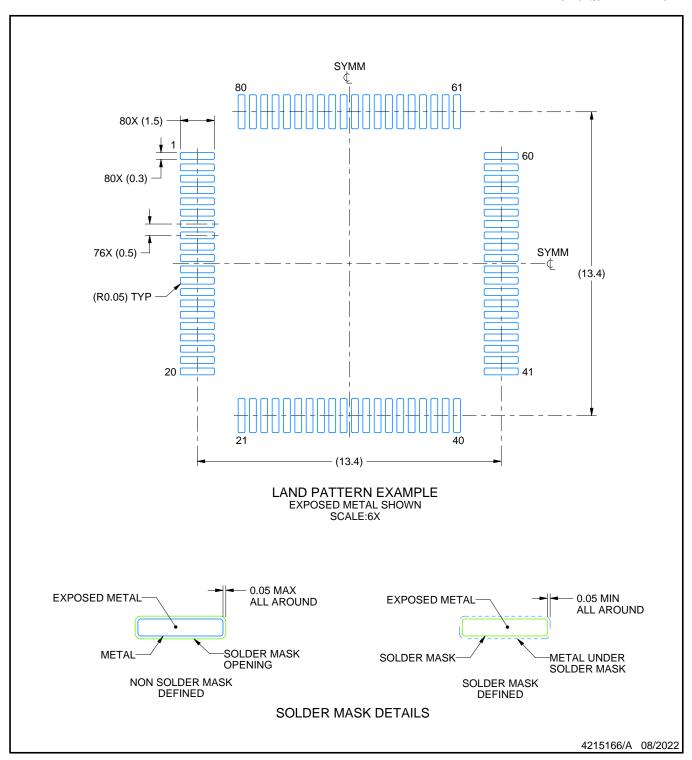
- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. Reference JEDEC registration MS-026.



PLASTIC QUAD FLATPACK

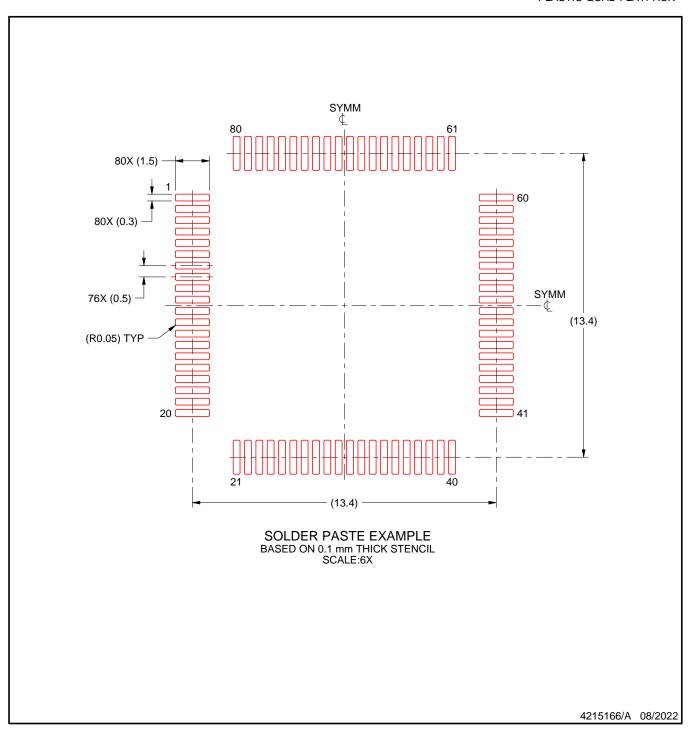


NOTES: (continued)

- 4. Publication IPC-7351 may have alternate designs.
- Solder mask tolerances between and around signal pads can vary based on board fabrication site.
 For more information, see Texas Instruments literature number SLMA004 (www.ti.com/lit/slma004).



PLASTIC QUAD FLATPACK



NOTES: (continued)



^{7.} Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

^{8.} Board assembly site may have different recommendations for stencil design.

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